

Electronic Acknowledgement Receipt

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1	Information Disclosure Statement (IDS) Filed (SB/08)	00038530.PDF	612592	no	4
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2	Foreign Reference	00038355.PDF	1319063	no	34
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4	NPL Documents	00038465.PDF	74926	no	3
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5	Foreign Reference	00038463.PDF	24172	no	1
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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

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